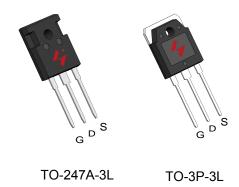


N-Channel Enhancement Mode MOSFET

Features

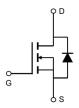
- 60V/190A $R_{DS(ON)} = 2.6 \text{ m}\Omega \text{ (typ.)} @ V_{GS} = 10V$
- 100% avalanche tested
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

Pin Description



Applications

- Switching application
- Power Management for Inverter Systems.



N Channel MOSFET

Ordering and Marking Information



Package Code

W: TO-247A-3L A: TO-3P-3L

Date Code Assembly Material YYXXX WW G: Lead Free Device

Note: HUAYI lead -free products contain molding compounds/die attach materials and 100% matte tin plate Termination finish; which are fully compliant with RoHS. HUAYI lead -free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this pr-oduct and/or to this document at any time without notice.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
Common	Ratings (T _C =25°C Unless Otherwise Noted)			•
V _{DSS}	Drain-Source Voltage		60	V
V _{GSS}	Gate-Source Voltage		±25	
TJ	Maximum Junction Temperature		175	°C
T _{STG}	Storage Temperature Range		-55 to 175	°C
Is	Diode Continuous Forward Current	T _C =25°C	190	А
Mounted	on Large Heat Sink			•
I _{DM}	Pulsed Drain Current *	T _C =25°C	720**	А
	Continuous Drain Current	T _C =25°C	190	A
I _D		T _C =100°C	128	
В	Maximum Dowar Discipation	T _C =25°C	283	W
P _D	Maximum Power Dissipation	T _C =100°C	141	vv
$R_{\theta JC}$	Thermal Resistance-Junction to Case	•	0.53	°C/W
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient		40	
Avalanch	e Ratings			*
E _{AS}	Avalanche Energy, Single Pulsed	L=0.5mH	1.3***	J

Note: * Repetitive rating; pulse width limited by junction temperature

** Drain current is limited by junction temperature

Electrical Characteristics $(T_c = 25^{\circ}C \text{ Unless Otherwise Noted})$

Cymbal	Dorometer	Test Conditions	HY3906		;	Unit	
Symbol	Parameter	rest Conditions	Min.	Тур.	Max.	Oilit	
Static Cha	racteristics		•	•			
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V, I_{DS} =250 μ A	60	-	-	V	
	Zoro Coto Voltago Drain Current	V _{DS} =60V, V _{GS} =0V	-	-	1		
I _{DSS}	Zero Gate Voltage Drain Current	T _J =85°C	-	-	10	μΑ	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_{DS}=250\mu A$	2.0	3.0	4.0	V	
I _{GSS}	Gate Leakage Current	V_{GS} =±25V, V_{DS} =0V	-	-	±100	nA	
R _{DS(ON)} *	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =95A	-	2.6	3.5	mΩ	
Diode Cha	Diode Characteristics						
V _{SD} *	Diode Forward Voltage	I _{SD} =95A, V _{GS} =0V	-	0.8	1.2	V	
t _{rr}	Reverse Recovery Time	05 A dl /dt 100 A /v.o.	-	48	-	ns	
Q _{rr}	Reverse Recovery Charge	I_{SD} =95A, dI_{SD}/dt =100A/ μ s	-	72	-	nC	



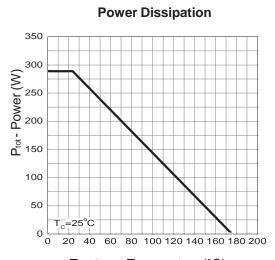
Electrical Characteristics (Cont.) $(T_c = 25^{\circ}C \text{ Unless Otherwise Noted})$

Symbol	Davameter	Test Conditions	H	HY3906		Unit	
Symbol	Parameter	rest Conditions	Min.	Тур.	Max.		
Dynamic (Characteristics						
R _G	Gate Resistance	V _{GS} =0V,V _{DS} =0V,F=1MHz	-	1.9	-	Ω	
C _{iss}	Input Capacitance	$V_{GS}=0V$,	-	5903	-		
C _{oss}	Output Capacitance	V _{DS} =25V,	-	1014	-	pF	
C _{rss}	Reverse Transfer Capacitance	Frequency=1.0MHz	-	506	-		
t _{d(ON)}	Turn-on Delay Time	V_{DD} =30V, R_{G} =6 Ω , I_{DS} =95A, V_{GS} =10V,	-	28	-		
Tr	Turn-on Rise Time		-	18	-	ns	
t _{d(OFF)}	Turn-off Delay Time		-	42	-	115	
T _f	Turn-off Fall Time		-	54	-		
Gate Charge Characteristics							
Qg	Total Gate Charge	V _{DS} =48V, V _{GS} =10V, I _{DS} =95A	-	135	-		
Q_gs	Gate-Source Charge		-	24	-	nC	
Q_{gd}	Gate-Drain Charge		-	49	-		

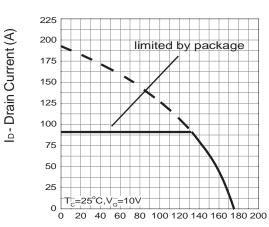
Note * : Pulse test ; pulse width $\leq\!300\mu s,$ duty cycle $\!\leq\!2\%.$



Typical Operating Characteristics



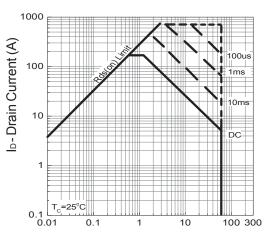
Drain Current



T_c- Case Temperature (°C)

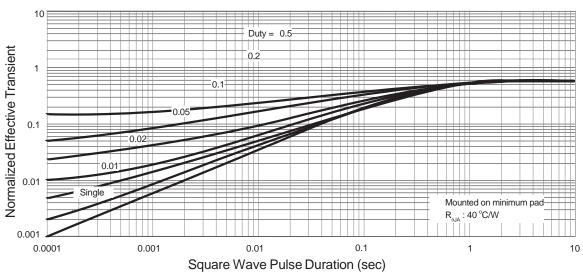
T_c-Case Temperature (°C)

Safe Operation Area



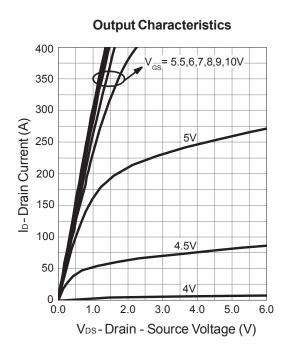
V_{DS} - Drain - Source Voltage (V)

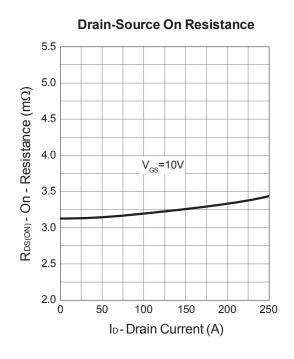
Thermal Transient Impedance

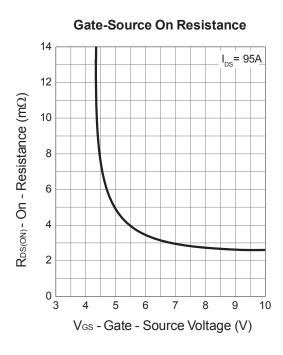


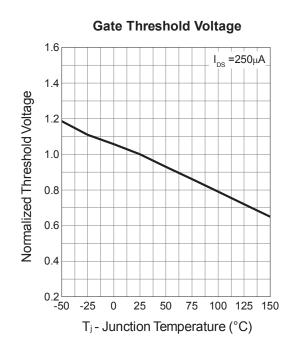


Typical Operating Characteristics (Cont.)





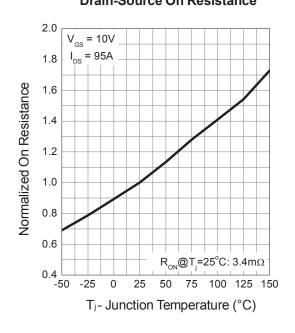




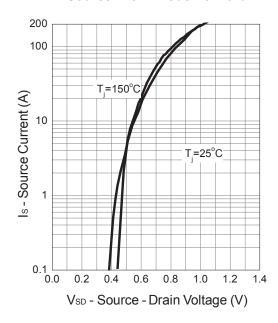


Typical Operating Characteristics (Cont.)

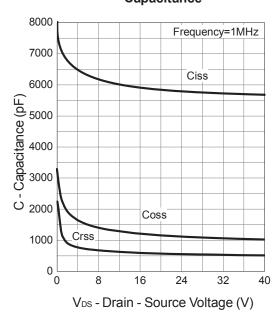
Drain-Source On Resistance



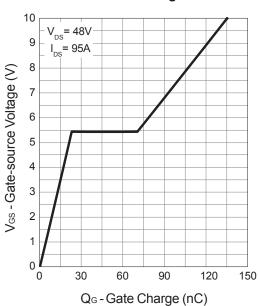
Source-Drain Diode Forward



Capacitance

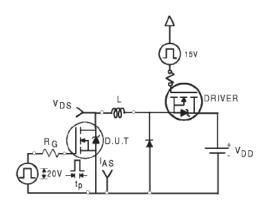


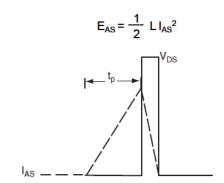
Gate Charge



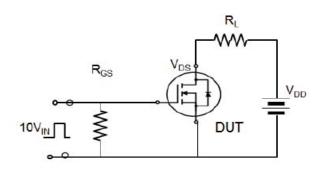


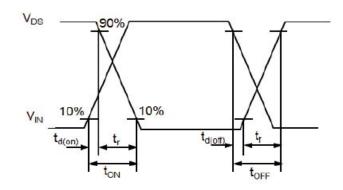
Avalanche Test Circuit



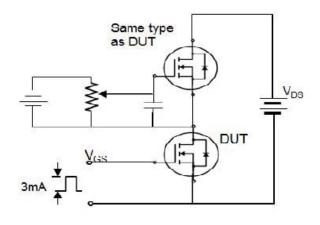


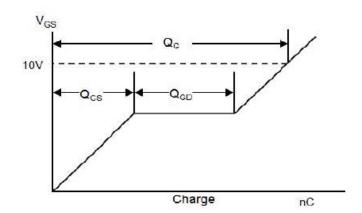
Switching Time Test Circuit





Gate Charge Test Circuit





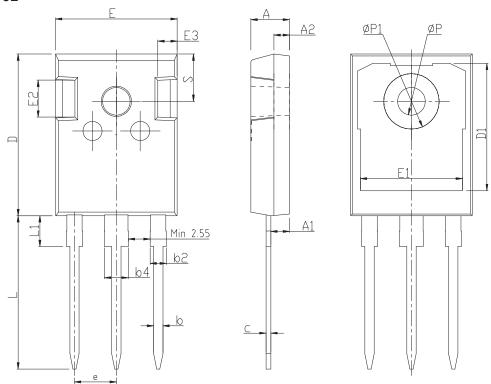


Device Per Unit

Package Type	Unit	Quantity
TO-247A-3L	Tube	30

Package Information

TO-247A-3L



COMMON DIMENSIONS

	CYNTROL MM		
SYMBOL	MIN	NOM	MAX
A	4.80	5. 00	5. 20
A1	2. 21	2.41	2.61
A2	1.85	2.00	2. 15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3. 01	3. 21
С	0.51	0.61	0.75
D	20.70	21.00	21.30
D1	16. 25	16.55	16.85
Е	15.50	15.80	16. 10
E1	13.00	13.30	13.60
E2	4.80	5.00	5. 20
E3	2.30	2.50	2.70
е		5. 44BSC	
L	19.62	19.92	20. 22
L1	_	_	4.30
P	3.40	3.60	3.80
P1	_	_	7.30
S	6. 15BSC		

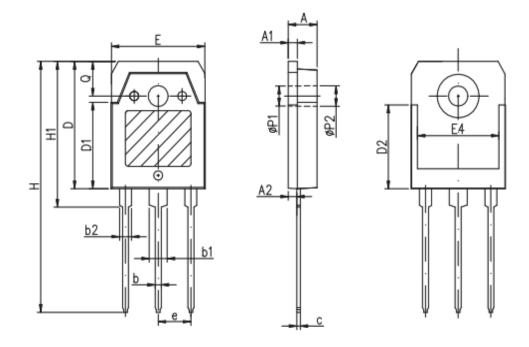


Device Per Unit

Package Type	Unit	Quantity
TO-3P-3L	Tube	30

Package Information

TO-3P-3L

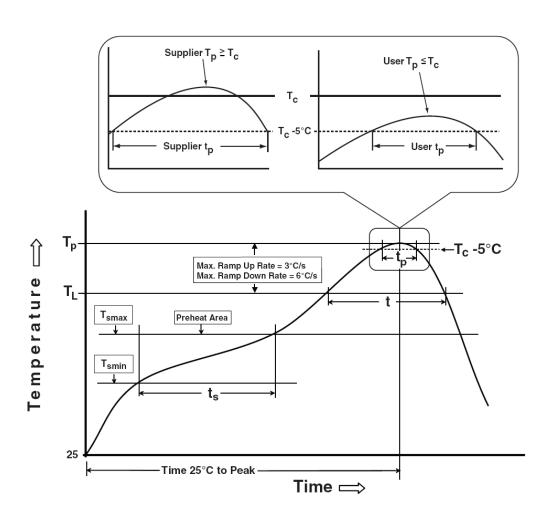


COMMON DIMENSIONS

SYMBOL		mm	
SIMBUL	MIN	NOM	MAX
A	4.60	4.80	5.00
A1	1.40	1.50	1.65
A2	1.18	1.38	1.58
b	0.80	1.00	1.20
b1	2.80	3.00	3. 20
b2	1.80	2.00	2.20
c	0.50	0.60	0.75
D	19.60	19.90	20. 20
D1	13. 55	13.90	14. 25
D2		12.90	REF
Е	15. 35	15.60	15. 85
E4	12.60	ı	_
е		5.45	TYP
Н	40. 10	40.50	40. 90
H1	23. 15	23. 40	23. 65
ФР1		3.20	REF
ФР2		3.50	REF



Classification Profile



Classification Reflow Profiles

Sn-Pb Eutectic Assembly	Pb-Free Assembly
100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds
3 °C/second max.	3°C/second max.
183 °C 60-150 seconds	217 °C 60-150 seconds
See Classification Temp in table 1	See Classification Temp in table 2
20** seconds	30** seconds
6 °C/second max.	6 °C/second max.
6 minutes max.	8 minutes max.
	100 °C 150 °C 60-120 seconds 3 °C/second max. 183 °C 60-150 seconds See Classification Temp in table 1 20** seconds 6 °C/second max.

Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum. Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.



Table 1. SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm ³ <350	Volume mm³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process - Classification Temperatures (Tc)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	168 Hrs /500 Hrs /1000 Hrs, Bias @ 150°C
PCT	JESD-22, A102	96Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -55°C~150°C

Customer Service

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